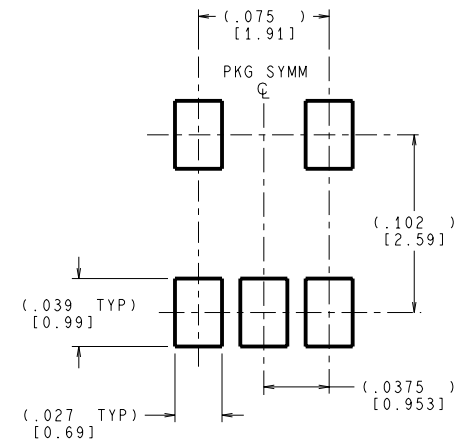
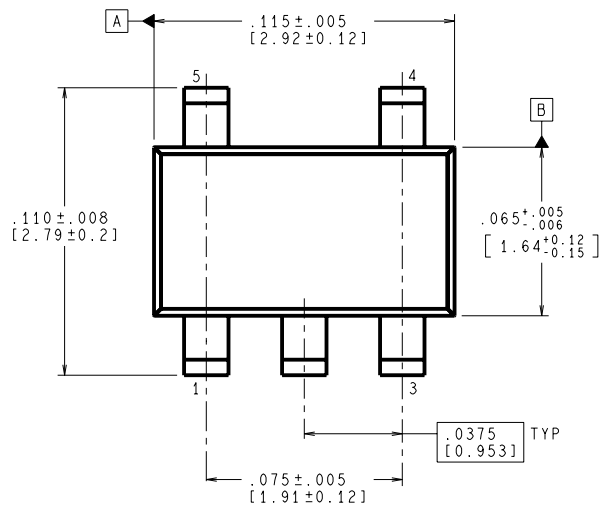
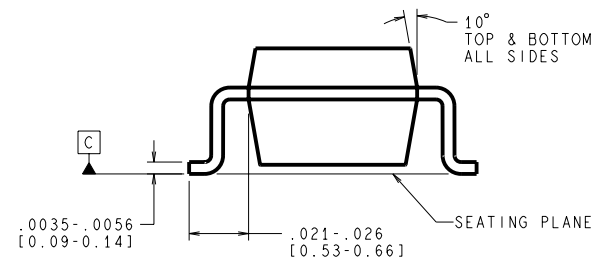
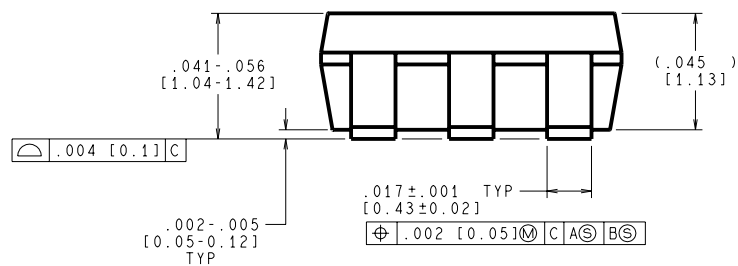


REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
E	ADD COPLANARITY; REVISE NOTES; REDRAW ON PRO/E PER CURRENT STD'S.	11929	03/30/1998	MS/



LAND PATTERN RECOMMENDATION

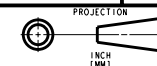


CONTROLLING DIMENSION IS INCH
VALUES IN () ARE MILLIMETERS

NOTES: UNLESS OTHERWISE SPECIFIED

- STANDARD LEAD FINISH TO BE 200 MICROINCHES/ 5.08 MICROMETERS MINIMUM TIN/LEAD (SOLDER) ON ALLOY 42.
- NO JEDEC REGISTRATION AS OF MAR 1998.

APPROVALS		DATE	 2900 Semiconductor dr., Santa Clara, CA 95052-8090		
DRAWN	MARTA SUCHY	03/30/1998			
DFTG. CHK.			MOLDED PACKAGE, SOT-23-5, 5 LEAD		
ENGR. CHK.					
			SCALE	SIZE	DRAWING NUMBER
			N/A	C	(SC)MKT-MA05A
			DO NOT SCALE DRAWING		REV E



SHEET 1 of 1